## DECLARATION AND POWER OF ATTORNEY U.S.A.

ALL PATENTS, INCLUDING DESIGN FOR APPLICATION BASED ON PCT. PARIS CONVENTION; NON PRIORITY; OR PROVISIONAL APPLICATIONS

EYS' USE ONLY DOCKET NO.		
 	 	<u>:</u>

METHOD FOR FORMING DEVICE ISOLATION FILM OF SEMICONDUCTOR DEVICE					
which is described and claim	ned in: PCT Internatio	nal Application No.	filed		
the attached specification	n the specification	on in application Serial No.	filed		
	(if applicable) ar	nd amended on			
any amendment referred to a l acknowledge the duty to di l hereby claim foreign priori	above. isclose information which is mat ity benefits under Title 35, Unit have also identified below any f	ontents of the above-identified specificaterial to patentability as defined in Title sed States code, §119 (a)-(d) of any forforeign application for patent or invento	37, Code of Federal Regulations reign application(s) for patent or	, §1.56. inventor's	
2002-42462	KR	19/07/2002			
(Number)	(Country)	(Day/Month/Year Filed)	Yes No		
(Number)	(Country)	(Day/Month/Year Filed)	Yes No		
(Number)	(Country)	(Day/Month/Year Filed)	Yes No		
I hereby claim the benefit un	nder Title 35, United States Cod	le, §119(e) of any United States provision	onal application(s) listed below:		
Application No.	Filing Date	Application No.	Filing Date		
subject matter of each of the	e claims of this application is n United States Code, §112, acl	Code, §120 of any United States appl not disclosed in the prior United States knowledge the duty to disclose inform hich became available between the f	application in the manner provi nation which is material to pater	ded by the ntability as	
defined in Title 37, Code o national or PCT internationa (Application Serial No WER OF ATTORNEY: As a na	al filing date of this application:  o.)  (amed inventor, I hereby appoin	at the following attorneys (Registration	Status: patented, pending, aband	n, receive	
defined in Title 37, Code on national or PCT internationa  (Application Serial Not WER OF ATTORNEY: As a nad act on instruction from my age. (20,851); JOHN CLARKE HOL NATHAN L. SCHERER (29,851) MPHRIES (22,772)	o.) and transact all business in LMAN (22,769); MARVIN R. ST L); IRWIN M. AISENBERG (19,0	at the following attorneys (Registration the Patent and Trademark Office configency); ALLEN S. MELSER (27, 2007); WILLIAM E. PLAYER (31,409); You have the configuration of the c	No.) to prosecute this application nected therewith, HARVEY B. JA 7,215); MICHAEL R. SLOBASKY OON S. HAM (45,307) and NATI	on, receive COBSON, ( (26,421);	
defined in Title 37, Code on national or PCT internationa  (Application Serial Note of the Note of ATTORNEY: As a national act on instruction from my age. (20,851); JOHN CLARKE HOL NATHAN L. SCHERER (29,851)	o.) and transact all business in LMAN (22,769); MARVIN R. ST L); IRWIN M. AISENBERG (19,0	of the following attorneys (Registration to the Patent and Trademark Office configer) (20,640); ALLEN S. MELSER (2007); WILLIAM E. PLAYER (31,409); YOUR DIRECT TELEPHONE CALLS	No.) to prosecute this application nected therewith, HARVEY B. JA 7,215); MICHAEL R. SLOBASKY OON S. HAM (45,307) and NATI	on, receive COBSON ( (26,421)	

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I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under section 1001 of Title 18 of the United States Code; and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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DATE 2003.06.04	DATE 2007. 06. 54	DATE 2003.06.04

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I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under section 1001 of Title 18 of the United States Code; and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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